

S/N 09/782441

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wing-Cheong G. Lai et al.

Examiner: Tuan Quach

Serial No.: 09/782441

Group Art Unit: 2814

Filed: February 13, 2001

Docket No.: 303.261US2

Title: SMALL GRAIN SIZE, CONFORMAL ALUMINUM INTERCONNECTS AND
METHOD FOR THEIR FORMATION



AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on June 20, 2003. Please amend the above-identified patent application as follows.

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